# PRESS RELEASE 

## MultiLambdaChip project gets underway

## New lasers for digital holography

Modern optical measurement techniques such as digital holography enable inline quality assurance. Until now, the size and cost of the light sources have prevented these measurement techniques from becoming widely established. As part of the MultiLambdaChip research project, Fraunhofer IPM is developing highly integrated, cost-effective laser light sources for use in digital holography, working in collaboration with HÜBNER Photonics, Carl Zeiss AG, cyberTECHNOLOGIES GmbH and the Laboratory for Optical Systems at the University of Freiburg.

The quality assurance of critical components is becoming more and more challenging: An ever wider range of components has to be surveyed at ever shorter cycle rates with ever higher levels of precision - and, ideally, directly on the production line. Optical measurement techniques are best suited to this task. However, the size and cost of the required laser light sources are often limiting factors to using these techniques on a wider scale. In order to find a solution to this problem, Fraunhofer IPM has recently launched the MultiLambdaChip project together with four partners.

## Highly integrated and flexible

The project team aims to develop a new lithium niobate-based photonic circuit to produce a highly integrated, cost-effective and flexible multiwavelength laser light source. The plan is to manipulate and convert the 1550 nm light of an inexpensive type of laser diode normally used in telecommunications and enable it to take high-precision measurements in the visible spectral range. This cost-effective light source will make the use of holographic measurement systems cost-efficient for many new tasks in modern production.

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## Specific industrial applications

High-tech industries rely on many critical components with low tolerances being produced at high cycle rates. The production of microchips or high-performance electronics for e-mobility or renewable energy applications are good examples. Digital holography can, in principle, ensure reliable quality control in these scenarios. The light source being developed as part of MultiLambdaChip will make demanding in-line measuring tasks more and more affordable. The project sets out to prove the operational capability of the new laser light source used in combination with holographic measurement systems for two specific industrial applications. Firstly, a novel holographic line sensor is designed to enable quality assurance during bake-out of microchips for the first time. Secondly, a holographic sensor system capable of taking comprehensive measurements is due to be integrated into a multi-axis handling system to allow the dimensional accuracy of ceramic components to be 100 percent controlled. Achieving these objectives will, for the first time, make it possible to take high-precision in-line 3D measurements that could previously only be carried out in special measuring rooms.

## FURTHER INFORMATION

## The MultiLambdaChip project

The MultiLambdaChip project aims to develop an integrated optical multiwavelength laser system for holographic 3D surface metrology in industrial quality assurance. By researching, developing and testing this innovative solution, MultiLambdaChip is addressing the entire spectrum of challenges that go hand in hand with this new technology. Within the project, Fraunhofer IPM is responsible for developing an integrated optical multiwavelength laser system as well as a novel digital holographic 3D line sensor, before then overseeing their conversion into industrial practice.
The project partners are HÜBNER Photonics, Carl Zeiss AG, cyberTECHNOLOGIES GmbH, the Laboratory for Optical Systems at the University of Freiburg/IMTEK and Fraunhofer IPM. The project is funded by the German Federal Ministry of Education and Research.

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New laser light sources are being developed as part of the MultiLambdaChip project. They will provide an economically viable solution for demanding measuring tasks, such as those involved in the production of microchips. © Fraunhofer IPM

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[^0]:    Editorial notes
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[^1]:    The Fraunhofer-Gesellschaft, based in Germany, is the world's leading applied research organization. By prioritizing key technologies for the future and commercializing its findings in business and industry, it plays a major role in the innovation process. A trailblazer and trendsetter in innovative developments and research excellence, it is helping shape our society and our future. Founded in 1949, the Fraunhofer-Gesellschaft currently operates 76 institutes and research units throughout Germany. Around 30,800 employees, predominantly scientists and engineers, work with an annual research budget of roughly $€ 3.0$ billion, $€ 2.6$ billion of which is designated as contract research.

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